

# DFM600FXM12-A000

## Fast Recovery Diode Module

Replaces DS5478-1.3

#### DS5478-2 April 2010 (LN26759)

## **FEATURES**

- Low Reverse Recovery Charge
- High Switching Speed
- Low Forward Volt Drop
- Isolated AlSiC Base with AIN Substrates
- Dual Diodes can be paralleled for 1200A Rating
- Lead Free Construction

## **APPLICATIONS**

- Chopper Diodes
- Boost and Buck Circuits
- Free-wheel Circuits
- Multi-level Switch Inverters

The DFM600FXM12-A000 is a dual 1200V, fast recovery diode (FRD) module. Designed for low power loss, the module is suitable for a variety of high voltage applications in motor drives and power conversion.

Fast switching times and low reverse recovery losses allow high frequency operation, making the device suitable for the latest drive designs employing PWM and high frequency switching.

The module incorporates an electrically isolated base plate and low inductance construction enabling circuit designers to optimise circuit layouts and utilise grounded heat sinks for safety.

#### **ORDERING INFORMATION**

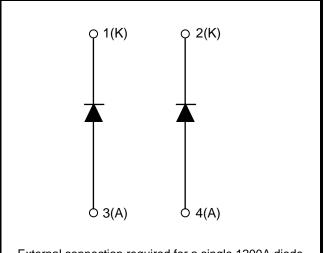
Order As:

#### DFM600FXM12-A000

Note: When ordering, please use the complete part number

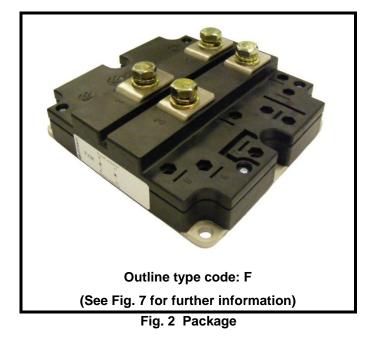
#### **KEY PARAMETERS**

V <sub>RRM</sub>		1200V
VF	(typ)	1.9V
I <sub>F</sub>	(max)	600A
I <sub>FM</sub>	(max)	1200A



External connection required for a single 1200A diode

Fig. 1 Circuit configuration



## **ABSOLUTE MAXIMUM RATINGS**

Stresses above those listed under 'Absolute Maximum Ratings' may cause permanent damage to the device. In extreme conditions, as with all semiconductors, this may include potentially hazardous rupture of the package. Appropriate safety precautions should always be followed. Exposure to Absolute Maximum Ratings may affect device reliability.

#### T<sub>case</sub> = 25°C unless stated otherwise

Symbol	Parameter	Test Conditions	Max.	Units
V <sub>RRM</sub>	Repetitive peak reverse voltage	T <sub>j</sub> = 125°C	1200	V
I <sub>F</sub>	Forward current (per arm)	DC, $T_{case} = 75^{\circ}C$ , $T_{j} = 125^{\circ}C$	600	А
I <sub>FM</sub>	Max. forward current	$T_{case} = 110^{\circ}C, t_{p} = 1ms$	1200	А
l <sup>2</sup> t	I <sup>2</sup> t value fuse current rating	$V_{R} = 0, t_{p} = 10ms, T_{j} = 125^{\circ}C$	100	kA <sup>2</sup> s
P <sub>max</sub>	Max. transistor power dissipation	$T_{case} = 25^{\circ}C, T_{j} = 125^{\circ}C$	2500	W
V <sub>isol</sub>	Isolation voltage – per module	Commoned terminals to base plate. AC RMS, 1 min, 50Hz	2500	V
Q <sub>PD</sub>	Partial discharge – per module	IEC1287, $V_1 = 1300V$ , $V_2 = 1000V$ , 50Hz RMS	10	рС

## THERMAL AND MECHANICAL RATINGS

Internal insulation material:	AIN
Baseplate material:	AlSiC
Creepage distance:	20mm
Clearance:	10mm
CTI (Comparative Tracking Index):	350

Symbol	Parameter	Test Conditions	Min	Тур.	Мах	Units
R <sub>th(j-c)</sub>	Thermal resistance (per arm)	Continuous dissipation – junction to case	-	-	40	°C/kW
R <sub>th(c-h)</sub>	Thermal resistance – case to heatsink (per module)	Mounting torque 5Nm (with mounting grease)	-	-	8	°C/kW
Tj	Junction temperature		-	-	125	°C
T <sub>stg</sub>	Storage temperature range		-40	-	125	°C
	Sorow Torquo	Mounting – M6	-	-	5	Nm
Screw Torque		Electrical connections – M8	-	-	10	Nm

## STATIC ELECTRICAL CHARACTERISTICS – PER ARM

#### T<sub>case</sub> = 25°C unless stated otherwise.

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
I <sub>RM</sub>	Peak reverse current	V <sub>R</sub> = 1200V, T <sub>j</sub> = 125°C			15	mA
V <sub>F</sub> Forward volt		I <sub>F</sub> = 600A		1.9	2.2	V
	Forward voltage	I <sub>F</sub> = 600A, T <sub>j</sub> = 125°C		2.1	2.4	V
L <sub>M</sub>	Inductance			20		nH

## STATIC ELECTRICAL CHARACTERISTICS

#### T<sub>case</sub> = 25°C unless stated otherwise.

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
L <sub>M</sub>	Module inductance (externally connected in parallel)			15		nH

## **DYNAMIC ELECTRICAL CHARACTERISTICS – PER ARM**

## T<sub>case</sub> = 25°C unless stated otherwise

Symbol	Parameter	Test Conditions	Min	Тур.	Max	Units
Q <sub>rr</sub>	Reverse recovery charge	I <sub>F</sub> = 600A		100		μC
I <sub>rr</sub>	Peak reverse recovery current	$V_R = 600V$		400		А
E <sub>rec</sub>	Reverse recovery energy	$dI_F/dt = 4500A/\mu s$		40		mJ

#### T<sub>case</sub> = 125°C unless stated otherwise

Symbol	Parameter	Test Conditions	Min	Тур.	Max	Units
Q <sub>rr</sub>	Reverse recovery charge	I <sub>F</sub> = 600A		150		μC
I <sub>rr</sub>	Peak reverse recovery current	$V_R = 600V$		475		А
E <sub>rec</sub>	Reverse recovery energy	$dI_F/dt = 4200A/\mu s$		70		mJ

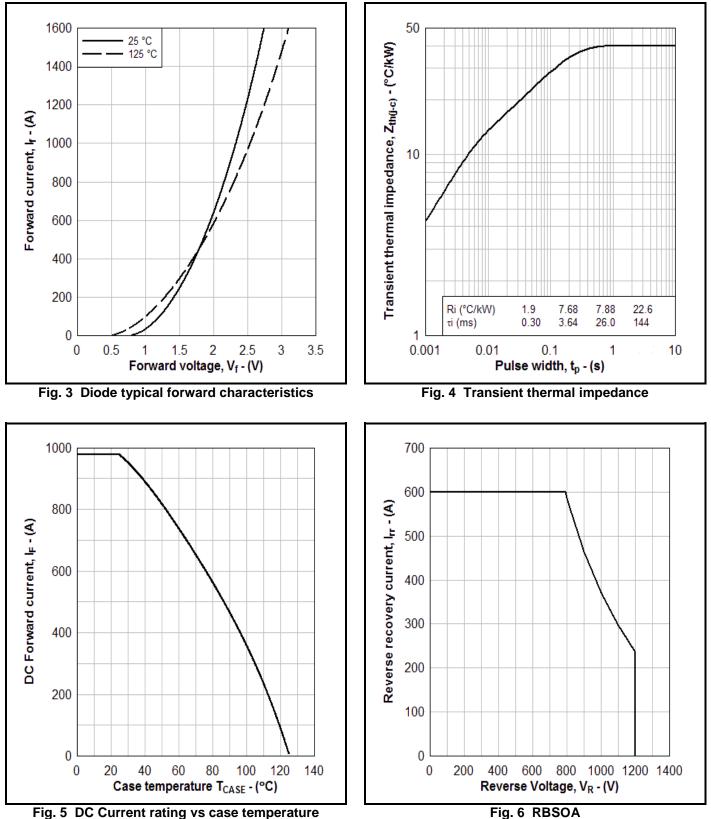
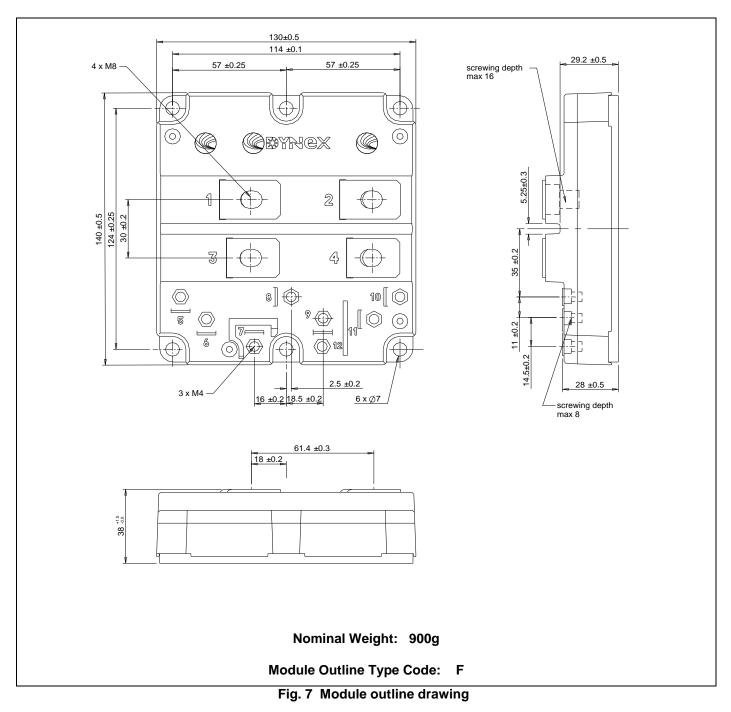


Fig. 5 DC Current rating vs case temperature



#### PACKAGE DETAILS

For further package information, please visit our website or contact Customer Services. All dimensions in mm, unless stated otherwise. **DO NOT SCALE.** 



## **HEADQUARTERS OPERATIONS**

#### DYNEX SEMICONDUCTOR LTD

Doddington Road, Lincoln Lincolnshire, LN6 3LF, United Kingdom

Fax: +44(0)1522 500550 Tel: +44(0)1522 500500

#### **CUSTOMER SERVICE**

#### DYNEX SEMICONDUCTOR LTD

Doddington Road, Lincoln Lincolnshire, LN6 3LF, United Kingdom

Fax: +44	(0)1522 500020
Tel: +44	(0)1522 502901 / 502753

email: <u>power\_solutions@dynexsemi.com</u>

#### © Dynex Semiconductor TECHNICAL DOCUMENTATION - NOT FOR RESALE. PRODUCED IN UNITED KINGDOM.

**Datasheet Annotations:** Dynex Semiconductor annotate datasheets in the top right hand corner of the front page, to indicate product status. The annotations are as follows:-

Target Information:	This is the most tentative form of information and represents a very preliminary specification. No actual work on the product has been started.
Preliminary Information:	The product is in design and development. The datasheet represents the product as it is understood but may change.
Advance Information:	The product design is complete and final characterisation for volume production is well in hand.
No Annotation:	The product parameters are fixed and the product is available to datasheet specification.

This publication is issued to provide information only which (unless agreed by the company in writing) may not be used, applied or reproduced for any purpose nor form part of any order or contract nor to be regarded as a representation relating to the products or services concerned. No warranty or guarantee expressed or implied is made regarding the capability, performance or suitability of any product or service. The Company reserves the right to alter without prior notice the specification, design or price of any product or service. Information concerning possible methods of use is provided as a guide only and does not constitute any guarantee that such methods of use will be satisfactory in a specific piece of equipment. It is the users responsibility to fully determine the performance and suitability of any equipment using such information and to ensure that any publication or data used is up to date and has not been superseded. These products are not suitable for use in any medical products whose failure to perform may result in significant injury or death to the user. All products and materials are sold and services provided subject to the Company's conditions of sale, which are available on request.

All brand names and product names used in this publication are trademarks, registered trademarks or trade names of their respective owners.